

SW088R06VT-VB Datasheet N-Channel 60-V (D-S) MOSFET

| PRODUCT | SUMMARY | | | | |
|---------------------|----------------------------------|---------------------------------|--|--|--|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) ^a | | | |
| 60 | 0.011 at V _{GS} = 10 V | 60 | | | |
| 00 | 0.013 at V _{GS} = 4.5 V | 50 | | | |

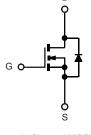
FEATURES

- 175 °C Junction Temperature
- TrenchFET[®] Power MOSFET
- Material categorization:

D







N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 $^{\circ}$ | C, unless otherv | vise noted) | | | |
|---|--|-----------------------------------|--------------------------------------|------|--|
| Parameter | | Symbol | Limit | Unit | |
| Gate-Source Voltage | | V _{GS} | ± 20 | V | |
| Continuous Drain Current (T = 175 °C)b | T _C = 25 °C | | 60 | | |
| Continuous Drain Current (T _J = 175 °C) ^b | $T_{\rm C} = 100 \ ^{\circ}{\rm C}$ $I_{\rm D}$ 50 | 50ª | | | |
| Pulsed Drain Current | | I _{DM} | 200 | А | |
| Continuous Source Current (Diode Conduction) | | I _S | 50ª | | |
| Avalanche Current | | I _{AS} 50 | | | |
| Single Avalanche Energy (Duty Cycle \leq 1 %) | L = 0.1 mH | E _{AS} | 125 | mJ | |
| Maximum Power Dissipation | T _C = 25 °C | P _D | 136 | w | |
| | $T_A = 25 \degree C$ | D'D | 3 ^b , 8.3 ^{b, c} | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Marinerum lumetiem te Ameliemta | t ≤ 10 sec | R _{thJA} | 15 | 18 | |
| Maximum Junction-to-Ambient ^a | Steady State | | 40 | 50 | °C/W |
| Maximum Junction-to-Case | | R _{thJC} | 0.85 | 1.1 | |

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. $t \le 10$ s.

| SPECIFICATIONS (T _J = 25 °C | , unless oth | erwise noted) | | | | | |
|---|---------------------|--|------|-------|-------|--|----|
| Parameter | Symbol | Test Conditions | Min. | Typ.ª | Max. | Unit | |
| Static | | | | | · · | | |
| Drain-Source Breakdown Voltage | V _{DS} | V_{GS} = 0 V, I _D = 250 µA | 60 | | | V nA μA A Ω S PF nC ns | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 1 | | 3 | v | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| | | V _{DS} = 60 V, V _{GS} = 0 V | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μA | |
| | | V _{DS} = 60 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | | |
| On-State Drain Current ^b | I _{D(on)} | V _{DS} = 5 V, V _{GS} = 10 V | 60 | | | А | |
| | | V _{GS} = 10 V, I _D = 20 A | | 0.011 | | | |
| | D | V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C | | 0.014 | | | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C | | 0.018 | | | |
| | | V _{GS} = 4.5 V, I _D = 15 A | | 0.013 | | | |
| Forward Transconductance ^b | g _{fs} | V _{DS} = 15 V, I _D = 20 A | | 60 | | S | |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | | | 4200 | | | |
| Output Capacitance | C _{oss} | V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz | | 570 | | V nA μA A Ω S pF | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 325 | | | |
| Total Gate Charge ^c | Qg | | | 47 | | | |
| Gate-Source Charge ^c | Q _{gs} | V _{DS} = 30 V, V _{GS} = 10 V, I _D = 50 A | | 10 | | nC | |
| Gate-Drain Charge ^c | Q _{gd} | | | 12 | | 1 | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 10 | 20 | | |
| Rise Time ^c | t _r | V_{DD} = 30 V, R _L = 0.6 Ω | | 15 | 25 | 20 | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 50$ A, V_{GEN} = 10 V, R_g = 2.5 Ω | | 35 | 50 | ns | |
| Fall Time ^c | t _f | | | 20 | 30 | | |
| Source-Drain Diode Ratings and Ch | aracteristics (| T _C = 25 °C) | | | | | |
| Pulsed Current | I _{SM} | | | | 60 | А | |
| Diode Forward Voltage | V _{SD} | I _F = 20 A, V _{GS} = 0 V | | 1 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | I _F = 20 A, di/dt = 100 A/μs | | 45 | 100 | ns | |

Notes:

a. For design aid only; not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

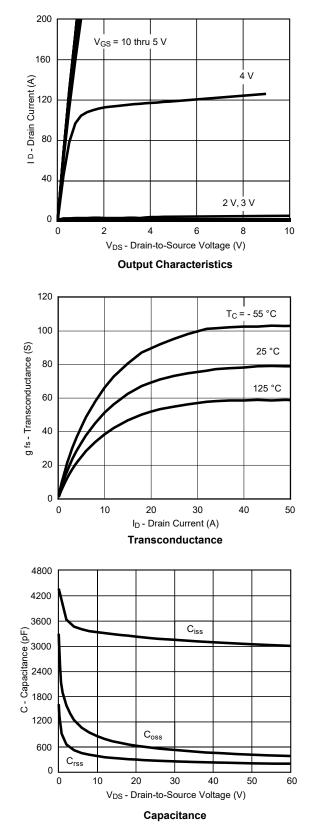
c. Independent of operating temperature.

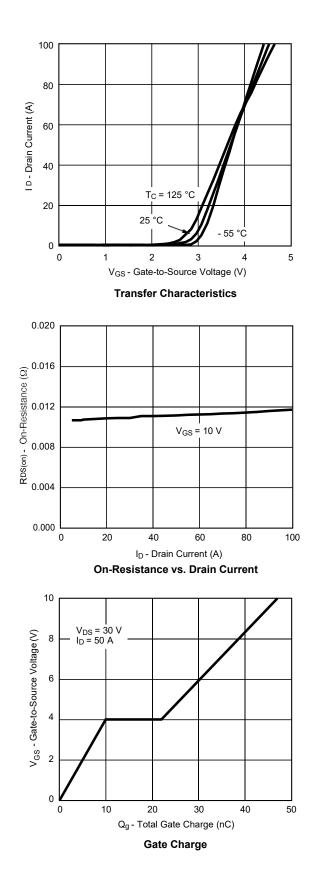
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (25 °C unless noted)

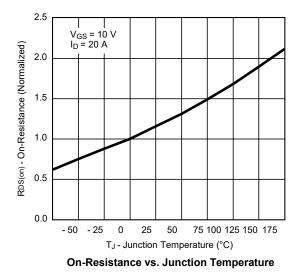




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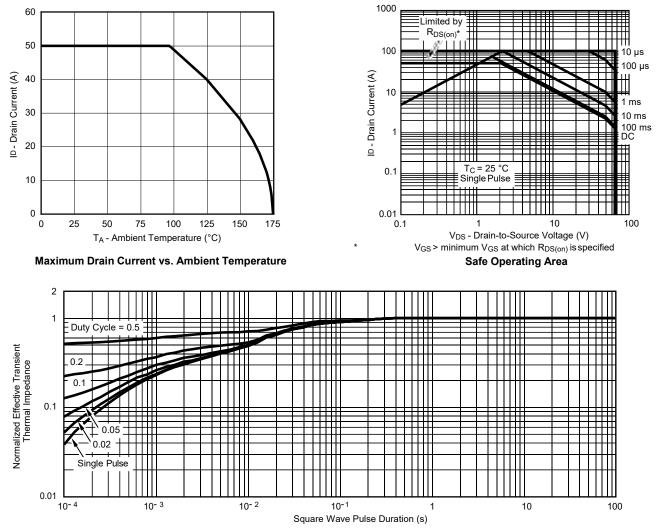
TYPICAL CHARACTERISTICS (25 °C unless noted)



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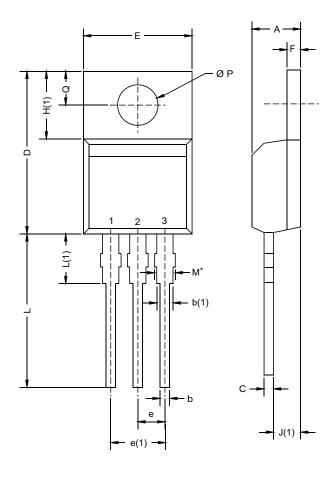
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



| DIM. | MILLIM | ETERS | INC | INCHES | | |
|-----------------------|-------------------|-----------|-------|--------|--|--|
| | MIN. | MAX. | MIN. | MAX. | | |
| А | 4.24 | 4.65 | 0.167 | 0.183 | | |
| b | 0.69 | 1.02 | 0.027 | 0.040 | | |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 | | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | | |
| D | 14.33 | 15.85 | 0.564 | 0.624 | | |
| Е | 9.96 | 10.52 | 0.392 | 0.414 | | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | | |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 | | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | | |
| L | 13.36 | 14.40 | 0.526 | 0.567 | | |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 | | |
| ØΡ | 3.53 | 3.94 | 0.139 | 0.155 | | |
| Q | 2.54 | 3.00 | 0.100 | 0.118 | | |
| ECN: X15- DWG: 603 | 0364-Rev. C, 1 | 14-Dec-15 | | | | |

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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